

规格书编号

SPEC NO: HDF1588EB5SP02

# 产品规格书 SPECIFICATION

CUSTOMER 客 户:						
PRODUCT 产品:	SAW FILTER					
MODEL NO 型 号:	HDF1588E-B2	<u> </u>				
MARKING 印字:	B044					
PREPARED 编 制:	CHECKED 审核:					
APPROVED 批准:	DATE日期: _	2016-4-13				
- 3		)				
客户确认 CUSTOMER RE	CEIVED:					
审核 CHECKED	批准 APPROVED	日期 DATE				

## 无锡市好达电子有限公司 Shoulder Electronics Limited

Factory Address: NO. 115, Gaoyun Road, Binhu Economic & Technology Development Area, Wuxi,

Jiangsu, China. Tel: 86-510-85629111

Country of origin: China





# 更改历史记录 History Record

更改日期 Date	规格书编号 Spec. No.	产品型号 Part No.	客户产品型号 Customer No.	更改内容描述 Modify Content	备注 Remark
2016-4-13	SP02	HDF1588E-B	4,	Complete specifications. Add product application, reliability and other information.	
		X			
		7	X/(		
		\-\-\-\-\-\-\-\-\-\-\-\-\-\-\-\-\-\-\-			

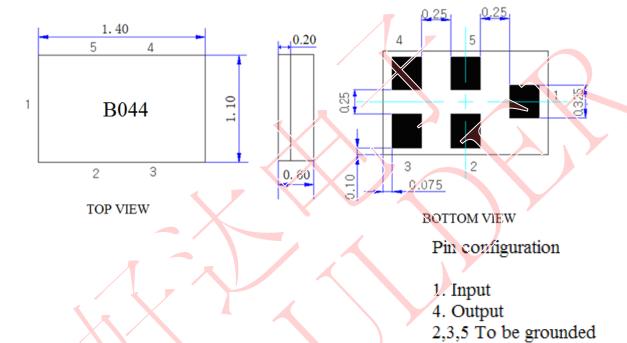


## 1. Application

**SAW FILTER** 

- Low-loss RF GPS + COMPASS + GLONASS filter
- Usable passband: 2.0 MHz for GPS, 4.092 MHz for COMPASS and 8.34 MHz for GLONASS
- Impedance 50 ohm input and output
- Unbalanced to unbalanced operation
- RoHS compatible

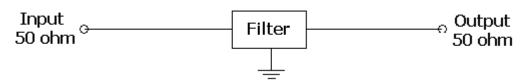
## **2. Package Dimension** (PKG SIZE 1.4 x 1.1mm)



3. Maximum Rating

Items	Conditions			
Operation temperature rang	-30°C ~+85°C			
Storage temperature rang	-40°C ~+85°C			
ESD voltage	ESD(MM): 50VDC			
Sensitive discharge device	ESD(HBM): 175VDC			
DC Voltage VDC	5V			
Max Input Power	15dBm 2000h			
Moisture Sensitivity Level	MSL 2			

## 4. Test Circuit



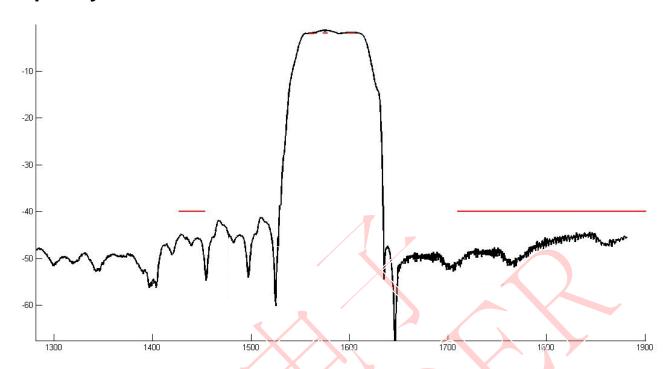


## 5. ELECTRICAL SPECIFICATION

		Unit	Minimum	Typical	Maximum
Center Frequency		MHz	-	1582.4	-
Insertion Loss					
1574.42~1576.42 MHz				1.3	1.5
1559.	.05~1563.15 MHz	dB		1.8	2.0
1573.	.37~1577.47 MHz			1.5	2.0
1597.	.78~1605.66 MHz			1.8	2.0
VSWR					
1574	.42~1576.42 MHz		7	1.2	2.0
1559.	.05~1563.15 MHz	dB		1.6	2.0
1573.	.37~1577.47 MHz			1.4	2.0
1597.	.78~1605.66 MHz			1.6	2.0
Group delay ripple		ne			
1597.	.78~1605.66 MHz	ns		4	12
Attenuation	X			1	
	10~824 MHz		47	51	
824~925 MHz 1427~1453 MHz 1710~1785 MHz		X	47	51	
			40	45	
			40	4 <i>5</i>	
	1850~1910 MHz	dB	40	44	-
	1920~1980 MHz		39	44	
	2400~2500 MHz		43	45	
	2500~2570 MHz		37	42	
2600~3000 MHz			30	38	
	4900~5850 MHz		15	24	
Input/Output Impedance		Ohms		50	



## 6. Frequency Characteristics



## 7. ENVIRONMENTAL CHARACTERISTICS

#### 7.1 High temperature exposure

Subject the device to +35°C for 16 hours. Then release the filter into the room conditions for 24 hours prior to the measurement. It shall fulfill the specifications in 5.

#### 7.2 Low temperature exposure

Subject the device to -40°C for 16 hours. Then release the device into the room conditions for 24 hours prior to the measurement. It shall fulfill the specifications in 5.

#### 7.3 Temperature cycling

Subject the device to a low temperature of -40% for 30 minutes. Following by a high temperature of +85% for 30 Minutes. Then release the device into the room conditions for 24 hours prior to the measurement. It shall meet the specifications in 5.

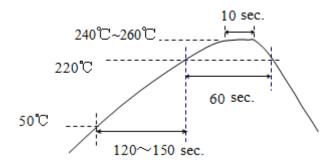
#### 7.4 Resistance to solder heat

- 1, immerge the solder bath at 260°C for 10 sec.
- 2, the iron at 370°C for 3 sec

#### 7.5 Solderability

Submerge the device terminals into the solder bath at  $245^{\circ}$ C  $\pm 5^{\circ}$ C for 5s, More than 95% area of the soldering pad must be covered with new solder. It shall meet the specifications in 5.

#### 7.6 Reflow soldering



The specimen shall be passed through the reflow furnace with the condition shown in the above profile for 1 time.

The specimen shall be stored at standard atmospheric conditions for 1h, after which the measurement shall be made. Test board shall be 1.6 mm thick. Base material shall be glass fabric base epoxy resin.

#### 7.7 Mechanical shock

Drop the device randomly onto the concrete floor from the height of 1m 3 times, the device shall fulfill the specifications in 5.

#### 7.8 Vibration

Subject the device to the vibration for 1 hour each in x,y and z axes with the amplitude of 1.5 mm at 10 to 55 Hz. The device shall fulfill the specifications in 5.

#### 8. REMARK

#### 8.1 Static voltage

Static voltage between signal load & ground may cause deterioration &destruction of the component. Please avoid static voltage.

#### 8.2 Ultrasonic cleaning

Ultrasonic vibration may cause deterioration & destruction of the component. Please avoid ultrasonic cleaning

#### 8.3 Soldering

Only pad component may be solded. Please avoid soldering another part of component.

## 9. Packing

#### 9.1 Dimensions

(1) Carrier Tape: Figure 1

(2) Reel: Figure 2

(3) The product shall be packed properly not to be damaged during transportation and storage.

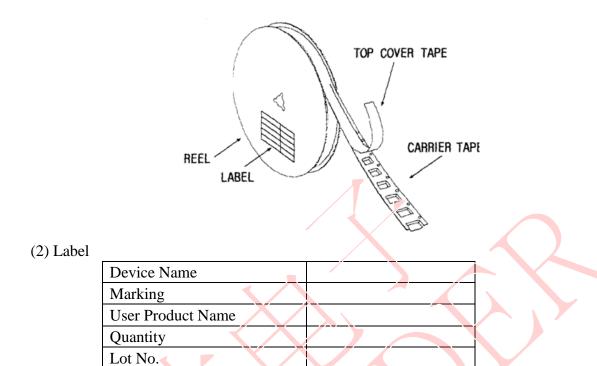
#### 9.2 Reeling Quantity

3000 pcs/reel φ 178mm 10000 pcs/reel φ 259mm

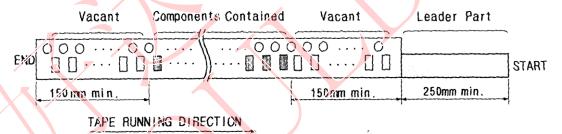
#### 9.3 Taping Structure

(1) The tape shall be wound around the reel in the direction shown below.





(3) Leader part and vacant position specifications.



## 10. TAPE SPECIFICATIONS

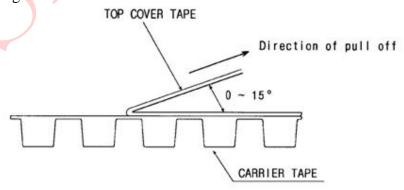
10.1 Tensile Strength of Carrier Tape: 4.4 N/mm width

10.2 Top Cover Tape Adhesion (See the below figure)

(1) pull off angle: 0~15°

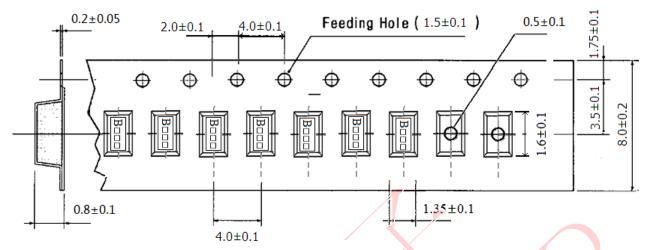
(2) speed: 300mm/min.

(3) force: 20~70g



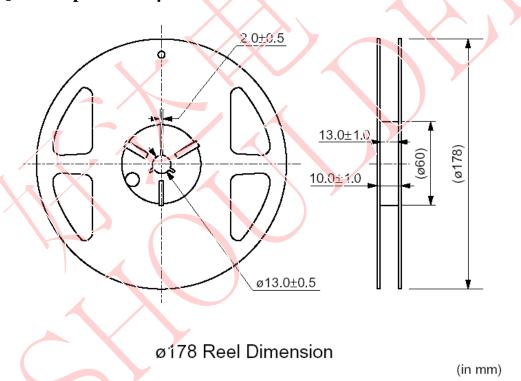


## [Figure 1] Carrier Tape Dimensions

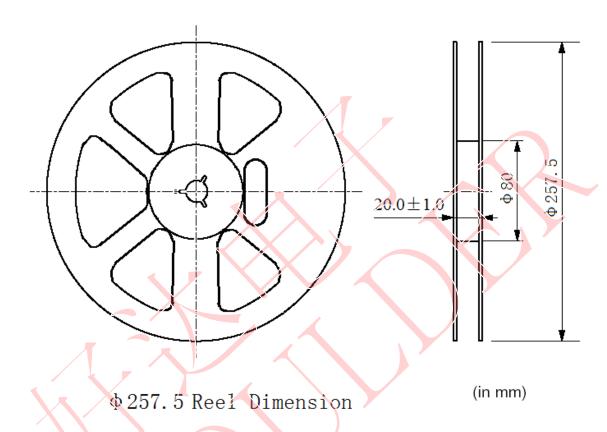


Tape Running Direction

[Figure 2] 3000 pcs/reel  $\phi$  178 inm



10000 pcs/reel φ 257.5mm



## **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Signal Conditioning category:

Click to view products by SHOULDER Electronics manufacturer:

Other Similar products are found below:

MAPDCC0004 PD0409J5050S2HF 880157 HHS-109-PIN DC1417J5005AHF DC4859J5005AHF AFS14A30-2185.00-T3 AFS14A35-1591.50-T3 DS-323-PIN DSS-313-PIN B39321R801H210 B39321R821H210 B39921B4317P810 1A0220-3 2089-6207-00 JP510S LFB212G45SG8C341 LFB322G45SN1A504 LFL182G45TC3B746 SF2159E 30057 1P510S CER0813B 3A325 40287 41180 ATB3225-75032NCT B69842N5807A150 BD0810N50100AHF BD2326L50200AHF BD2425J50200AHF HMC189AMS8TR C5060J5003AHF JHS-114-PIN JP503AS DC0710J5005AHF DC2327J5005AHF DC3338J5005AHF 43020 LFB2H2G60BB1C106 LFL15869MTC1B787 X3C19F1-20S XC3500P-20S 10013-20 SF2081E SF2194E SF2238E CDBLB455KCAX39-B0 RF1353C PD0922J5050D2HF